

Appl. No. 10/525,996  
Request for Corrected Filing Receipt dated Jan. 17, 2006  
Attorney Docket No. 1217-050618

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/525,996 Confirmation No. 6221  
Applicants : Hideo SENOO et al.  
Filed : February 28, 2005  
Title : Protective Structure of Semiconductor Wafer, Method for  
Protecting Semiconductor Wafer, Multilayer Protective Sheet  
Used Therein, and Method for Processing Semiconductor Wafer  
Gasoline Type  
Art Unit : 2811  
Examiner : Not yet assigned  
Customer No. : 28289

FACSIMILE NO. 703-305-9822  
Office of Initial Patent Examination's  
Filing Receipt Corrections  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR CORRECTED FILING RECEIPT**

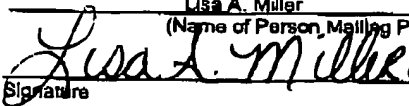
Sir:

Attached is a marked-up copy of the official Filing Receipt for the above-identified patent application for which a Corrected Filing Receipt is hereby requested. The domestic priority data as claimed by applicant is missing and should read as follows: -- US 11/129,583 filed May 13, 2005 --


-- US 60/571,475 filed May 14, 2004 --

A copy of the Declaration and Power of Attorney is enclosed for verification.

Respectfully submitted,  
THE WEBB LAW FIRM

<b>FACSIMILE TRANSMISSION</b>	
I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office on the date set forth below.	
Lisa A. Miller (Name of Person Mailing Paper)	
	02/27/2006
Signature	Date

By

  
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